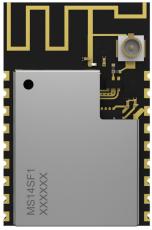
MINEWSEMI

Wi-Fi Module MS14SF1



Datasheet v 1.0.0

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MS14SF1-nRF7002

Low-power, Dual-band 2.4&5G Wi-Fi 6, Support TWT, Support STA/AP Mode

The MS14SF1 is a low-power, cost-effective wireless WiFi 6 module based on nRF7002. It integrates 2.4G and 5.8G dual-band 1T1R transceiver and LNA, as well as other powerful supporting development resources to provide a perfect solution for WiFi connection. The module has optional onboard antenna and IPEX external antenna, supports WPA/W-PA2/WPA3 encryption, supports STA/AP mode, and has a transmission distance of 80M in office environment, which can meet the needs of various structural scenarios.

FEATURES







High Cost-effective



Dual-band 2.4G + 5G, 1T1R



Support optional external antenna



Support TWT



Support STA/AP Mode



Transmission distance in office environment: 80M

KEY PARAMETER

| MS14SF1 | | | |
|-----------------------|-------------------------|---------------------------|-----------------------|
| Chip Model | nRF7002 | Antenna | PCB/IPEX |
| Module Size | 22.9×15×3mm | Firmware | None |
| Receiving Sensitivity | -98.6dBm | Transmission Power | Maximum +21dBm |
| Current(TX) | 191mA - 2.4G 260mA - 5G | Current(RX) | 60mA - 2.4G 56mA - 5G |

APPLICATION



Smart Buildings



Consumer Electronics



Smart Healthcare



Security Equipment



Automotive Devices



Smart Agriculture



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2 RELATED DOCUMENTS

- nRF7002_Chip_Datasheet
 https://en.minewsemi.com/file/nRF7002_Chip_Datasheet_EN.pdf
- MinewSemi_Product_Naming_Reference_Manual_V1.0
 https://en.minewsemi.com/file/MinewSemi_Product_Naming_Reference_Manual_EN.pdf
- MinewSemi_Connectivity_Module_Catalogue_V2.0
 https://en.minewsemi.com/file/MinewSemi_Connectivity_Module_Catalogue_EN.pdf



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